

APPROVAL SHEET

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| Part No. | : | R315 |
|----------|---|-----------|
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| Prepared by: | = f3 R |
|--------------|----------|
| Checked by: | 杨香味 |
| Approved by: | 21/18/90 |

Features

■ 1-port Resonator

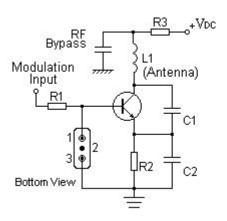
SAW Resonator

- Metal Case for **D11**
- Package size 8.36x3.45x1.70 mm³
- RoHS compatible
- Electrostatic Sensitive Device(ESD)

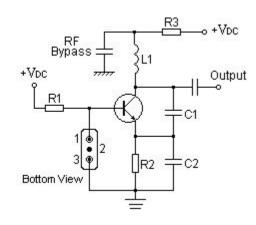


Application

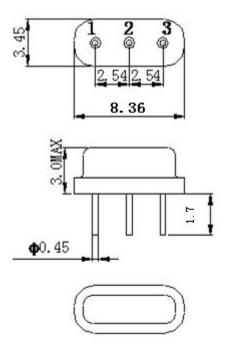
Typical Low-Power Transmitter Application



Typical Local Oscillator Application



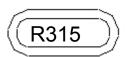
Package Dimensions (D11)



Pin Configuration

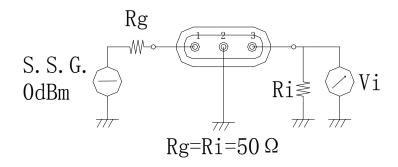
| 1 | Input/output |
|---|--------------|
| 3 | Output/Input |
| 2 | Ground |

Marking

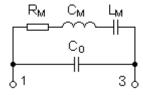


| R | SAW Resonator |
|-----|---------------|
| 315 | Part number |

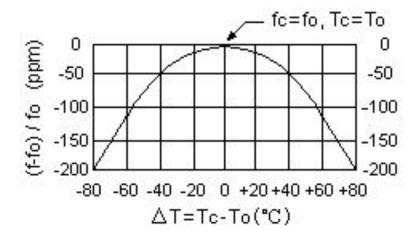
Test Circuit



Equivalent LC Model



Temperature Characteristics



The curve shown above accounts for resonator contribution only and does not include LC component temperature contributions.

Performance

Maximum Rating

| ltem | | Value | Unit |
|-----------------------|------------------|------------|---------------|
| DC Voltage | V _{DC} | ± 30 | V |
| Operation Temperature | Т | -40 ~ +85 | ${\mathbb C}$ |
| Storage Temperature | T _{stg} | -55 ~ +125 | ${\mathbb C}$ |
| RF Power Dissipation | Р | 10 | dBm |

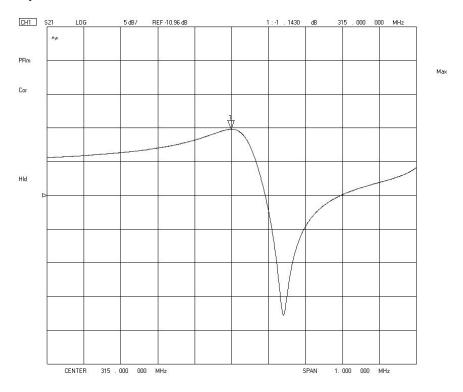
Electronic Characteristics

Test Temperature: $25^{\circ}C \pm 2^{\circ}C$

Terminating source impedance: 50Ω Terminating load impedance: 50Ω

| | Item | | Minimum | Typical | Maximum | Ųnit |
|--|-----------------------------------|----------------|---------|----------------|---------|--------------|
| Center | Absolute Frequency | fc | | 315.00 | | MHz |
| Frequency | Tolerance from 315.00MHz | △fc | | ± 75 | | KHz |
| Insertion Loss(n | ion Loss(min) IL 1.2 1.8 | | 1.8 | dB | | |
| Ovelity Factor | Unloaded Q | Qυ | | 16060 | | |
| Quality Factor | 50Ω Loaded Q | QL | | 1844 | | |
| | Turnover Temperature | T ₀ | 10 | 25 | 40 | $^{\circ}$ C |
| Temperature Stability | Turnover Frequency | f ₀ | | f _c | | KHz |
| • | Frequency Temperature Coefficient | FTC | | 0.032 | | ppm/℃ |
| Frequency Aging Absolute Value during the First Year | | f _A | | ≤ 10 | | ppm/yr |
| DC Insulation R | esistance between Any Two Pins | | 1.0 | | | MΩ |
| RF Equivalent | Motional Resistance | R _M | | 13 | 22 | Ω |
| | Motional Inductance | L _M | | 105.3 | | μН |
| RLC Model | Motional Capacitance | См | | 2.43 | | fF |
| | Static Capacitance | C ₀ | 2.8 | 3.1 | 3.4 | pF |

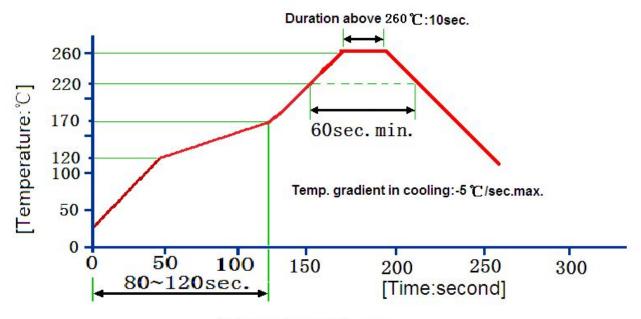
Frequency Response



Reliability (The SAW components shall remain electrical performance after tests)

| No. | Test item | Test condition | | |
|---------------------|---|---|--|--|
| 1 | Temperature | (1) Temperature: 85°C±2°C, Duration: 250h, Recovery time: 2h±0.5h | | |
| | Storage | (2) Temperature: –40 ℃±3 ℃ , Duration: 250h ,Recovery time: 2h±0.5h | | |
| 2 | Humidity Test | Conditions: 60℃±2℃,90~95% RH | | |
| 3 Thermal Shock | Heat cycle conditions: TA=-40℃±3℃, TB=85℃±2℃, t1=t2=30min, Switch | | | |
| | time: ≤3min , Cycle time: 100 times , Recovery time : 2h±0.5h. | | | |
| 4 Vibration Fatigue | | Frequency of vibration: 10~55Hz Amplitude:1.5mm | | |
| | Directions: X,Y and Z Duration: 2h | | | |
| 5 | Drop Test | Cycle time: 10 times Height: 1.0m | | |
| | | Temperature: 245℃±5℃ Duration: 3.0s5.0s | | |
| 6 | 6 Solder Ability Test | Depth: DIP2/3 , SMD1/5 | | |
| | | (1)Thickness of PCB:1mm , Solder condition: 260℃±5℃ , Duration: 10±1s | | |
| 7 | Resistance to | (2)Temperature of Soldering Iron: 350℃±10℃, Duration: 3~4s, | | |
| | Soldering Heat | Recovery time: 2 ± 0.5h | | |

Recommended Reflow Soldering Diagram



Reflow cycles:3 cycles max.

Notes

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may **be soldered**. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.

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